

# SERGE

## Ring Modulator 2017

### (RING) for 4U



The 2017 RING is an improved version of the late Serge Ring Modulator (R9), designed by Serge himself for Random\*Source in 2017, more than 40 years after the launch of the Serge Modular system.

To quote the Serge 1983 catalogue:

*“Our new RING MODULATOR (RING) is a brand new design which incorporates greatly improved specifications . Features include the following:*

- *A VERY CLEAN SOUND down to very low signal levels (unlike conventional modulators where distortion increases at low levels) .*
- *80 dbs OF CARRIER SIGNAL REJECTION.*

- *INAUDIBLE NOISE OUTPUT .*
- *NO SQUELCH CIRCUIT IS REQUIRED due to the low noise therefore annoying signal dropouts and “pumping” effects are totally absent.*
- *INTERNAL WAVESHAPING OF CARRIER to add to modulation effects.*
- *The sum total of these design improvements is a Ring Modulator capable of treating the most subtle acoustical signals, without the coloration typically associated with even the best previously available ring modulators.*

*The versatility of the Serge Ring Modulator is enhanced by the added feature of voltage and manual control of the entire spectrum of modulation possible: from zero modulation (i.e. the original, un-treated input signal) through amplitude modulation to full ring modulation. This allows many shadings of effect, manual or automatic with voltage controls. The ability to control the Carrier level manually and through voltage control allows the output to be level controlled, as well. -Through the use of an internal signal processor for the Carrier, additional effects can be produced by waveform modification of the carrier signal. When the module is set to full Ring Modulation from the lower knob or voltage control, the output signal contains the sum and difference frequencies of the Signal Input and the Carrier Input. If both signals are pure sine waves (only one frequency component), the output will be a composite signal consisting two frequency components: the sum and the difference frequency of the Signal and Carrier. If the Carrier level is increased beyond the*



## Bill of Materials

### Capacitors (min. 35V, 5mm lead spacing)

1	10uF	FILM / PET, 5mm	WIMA MKS2B051001N00JSSD (5% recommended)
1	4.7uF	FILM / PET, 5mm	WIMA MKS2 or similar, 5% recommended
3	1uF	FILM / PET, 5mm	WIMA MKS2 or similar - <b>ONLY IF NOT ALREADY INSTALLED IN SMT!</b>

### Trimpots

1	1k	Multiturn	e.g. Bourns 3296Y-1-102LF or Vishay T93YB102KT20
1	100k	Multiturn	e.g. Bourns 3296Y-1-104LF or Vishay
1	100k	Single-Turn (or multi-turn)	e.g. Bourns 3362P-1-104LF or whatever fits)

### Misc

1	MTA-156		MTA-156 power connector
3	Banana Jacks	SIGNAL IN, CARRIER IN, OUT	Emerson-Johnson
	BLACK		Thonk / Mouser: 530-108-0903-1 (black)
1	Banana Jack	CV input	Emerson-Johnson
	WHITE		Thonk / Mouser: 530-108-0910-1 (blue), 530-108-0901-1 (white)
3	Potentionmeter	linear (B50K)	Alpha 9mm vertical pcb mount
	50k		available from Thonk, Tayda, Mouser ...
			B100K should also work
2	SIL header 6pol		pin connectors, linking main pcb to component pcb - using precision strips allows to break off pieces as needed
4	Spacers + 8 matching screws (M3)		10mm or whatever matches the SIL headers / connectors

## Building

This is simply a suggestion - you might find a different workflow more practical:

1. Mount the banana jacks onto the front panel.
2. Use a side-cutter to separate main pcb and component pcb.
3. Solder the power connector and other through-hole parts to the main pcb.
4. Add the spacers to the panel pcb and install the pin (SIL) headers so that the 2 pcbs form a nice sandwich. **Pay attention to the direction the pcbs are facing - the SMT parts have to be inside the sandwich.** It is recommended to have the female headers on the panel pcb and the pins on the main pcb.
5. If you have double-checked that the positioning is correct, solder the pins connecting the 2 pcbs.

6. Carefully separate the 2 pcbs again and mount the pots onto the panel pcb. Pots should sit on the side facing the front panel (as marked on the board). Don't solder them in yet.
7. Carefully mount the panel pcb (with the pots etc. inserted) onto the front panel. You may then have to wiggle each pot a bit to get the pots through. Make sure the threads of the pots go through completely and the pots sit right at the front panel. Screw the jacks and pots to the panel to make sure of that.
8. Once everything is nicely in place, solder the pots (while the front panel is attached). Make sure you don't spill any solder on the SMT parts.
9. Solder the banana jacks in. You can either solder them directly to the surrounding vias (ring round) or - which makes removing easier should you ever need to do that - by inserting a stiff (bare) wire into the little hole (via) and solder that wire to the top of the banana jack:



10. Mount the main pcb again and fasten it using the spacers.
11. Connect a power cord supplying +12V, GND, GND, -12V to the power-header on the main board and double check the direction of the power header before you turn power on.
12. You should be ready to calibrate and go :-)